

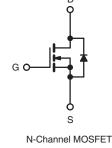
Vishay Siliconix

ROHS COMPLIANT

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	600				
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.40			
Q _g (Max.) (nC)	120				
Q _{gs} (nC)	29				
Q _{gd} (nC)	48				
Configuration	Single				





FEATURES

- Ultra Low Gate Charge
- Reduced Gate Drive Requirement
- Enhanced 30 V V_{GS} Rating
- Reduced C_{iss}, C_{oss}, C_{rss}
- Isolated Central Mounting Hole
- Dynamic dV/dt Rated
- Repetitive Avalanche Rated
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

This new series of low charge Power MOSFETs achieve significantly lower gate charge over conventional MOSFETs. Utilizing advanced Power MOSFETs technology the device improvements allow for reduced gate drive requirements, faster switching speeds and increased total system savings. These device improvements combined with the proven ruggedness and reliability of Power MOSFETs offer the designer a new standart in power transistors for switching applications.

The TO-247AC package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because of its isolated mounting hole.

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFPC60LCPbF
	SiHFPC60LC-E3
SnPb	IRFPC60LC
	SiHFPC60LC

ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V _{DS}	600	V		
Gate-Source Voltage			V _{GS}	± 30			
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	- I _D	16			
		T _C = 100 °C		10	А		
Pulsed Drain Current ^a			I _{DM}	64			
Linear Derating Factor				2.2	W/°C		
Single Pulse Avalanche Energy ^b			E _{AS}	1000	mJ		
Repetitive Avalanche Current ^a			I _{AR}	16	A		
Repetitive Avalanche Energy ^a			E _{AR} 28		mJ		
Maximum Power Dissipation	T _C =	25 °C	PD	280	W		
Peak Diode Recovery dV/dt ^c			dV/dt	3.0	V/ns		
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	*0		
Soldering Recommendations (Peak Temperature)	for 10 s		-	300 ^d	°C		
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in		
				1.1	N · m		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 7.2 mH, $R_g = 25 \Omega$, $I_{AS} = 16 \text{ A}$ (see fig. 12).

c. $I_{SD} \le 16$ A, dI/dt ≤ 140 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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PARAMETER	SYMBOL	TYP	. I	MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	- 40			UNIT			
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.24 - 0.45			°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}							
	' 'thjC			0.40				
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	vise noted)						
PARAMETER	SYMBOL			NS	MIN.	TYP.	MAX.	UNIT
Static					•	•		•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250	μA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D	= 1 mA	-	0.63	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250) μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 20 V$		-	-	± 100	nA
Zero Gate Voltage Drain Current	1	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-	-	25	
	IDSS		/, V _{GS} = 0 V, T	-	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$		9.6 A ^b	-	-	0.40	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 50 V, I _D = 9.	6 A	11	-	-	S
Dynamic		1			T	T	r	
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	3500	-	pF	
Output Capacitance	C _{oss}			-	400	-		
Reverse Transfer Capacitance	C _{rss}			g. 5	-	39	-	
Total Gate Charge	Qg			-	-	120	nC	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$ $I_D = 16 A_s$ see fig		N, V _{DS} = 360 V, g. 6 and 13 ^b	-	-		29
Gate-Drain Charge	Q _{gd}				-	-		48
Turn-On Delay Time	t _{d(on)}		•		-	17	-	
Rise Time	t _r	V_{DD} = 300 V, I _D = 16 A, R _g = 4.3 Ω, R _D = 18 Ω, see fig. 10 ^b		-	57	-	ns	
Turn-Off Delay Time	t _{d(off)}			-	43	-		
Fall Time	t _f	1			-	38	-	1
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	5.0	-	nH	
Internal Source Inductance	L _S			-	13	-		
Drain-Source Body Diode Characteristic	s							•
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	-	16	A	
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode			-	-		64
Body Diode Voltage	V_{SD}	$T_{J} = 25 \ ^{\circ}C, I_{S} = 16 \ A, V_{GS} = 0 \ V^{b}$		-	-	1.8	V	
Body Diode Reverse Recovery Time	t _{rr}			-	650	980	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	− T _J = 25 °C, I _F = 16 A, dI/dt = 100 A/μs			-	6.0	9.0	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	Irn-on time is	pogligible (turn	-on is dor	ninated h	v Loand	1-2)

Notes

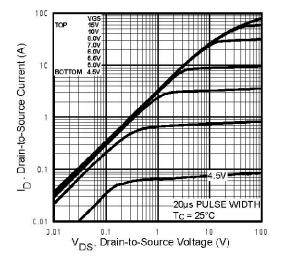
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^{\circ}C$

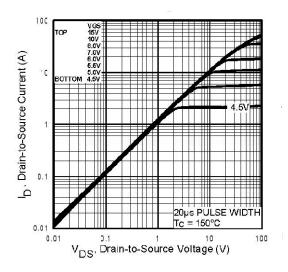
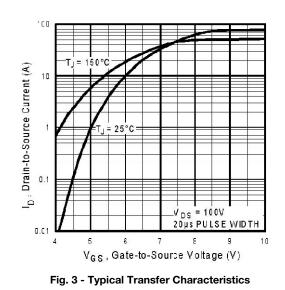


Fig. 2 -Typical Output Characteristics, T_C = 150 °C



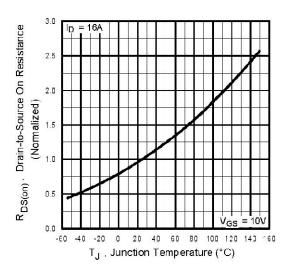


Fig. 4 - Normalized On-Resistance vs. Temperature

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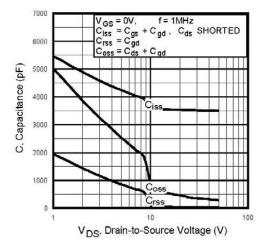


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

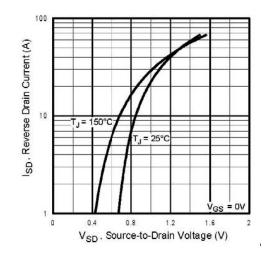


Fig. 7 - Typical Source-Drain Diode Forward Voltage

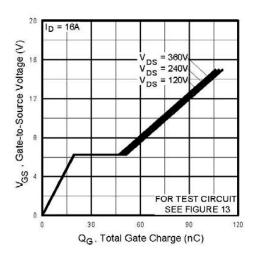


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

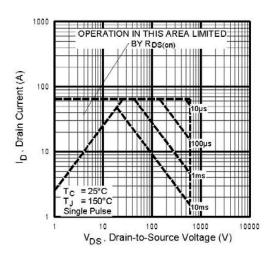


Fig. 8 - Maximum Safe Operating Area

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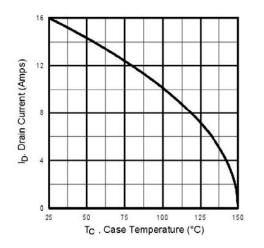


Fig. 9 - Maximum Drain Current vs. Case Temperature

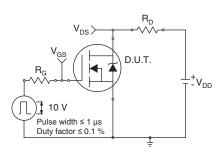


Fig. 10a - Switching Time Test Circuit

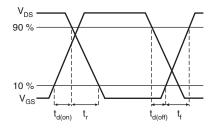
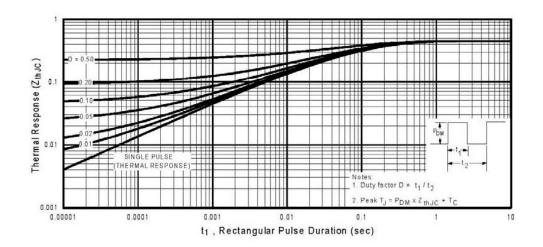
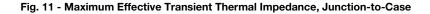


Fig. 10b - Switching Time Waveforms





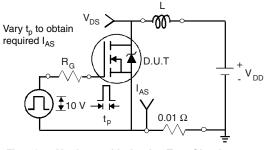


Fig. 12a - Unclamped Inductive Test Circuit

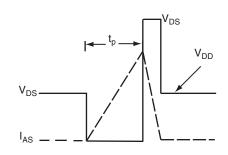


Fig. 12b - Unclamped Inductive Waveforms

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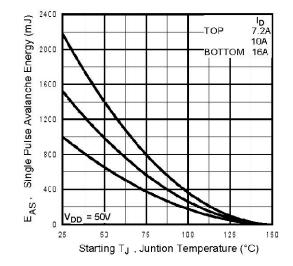


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

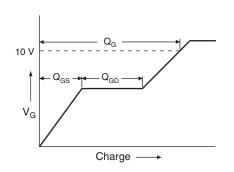


Fig. 13a - Basic Gate Charge Waveform

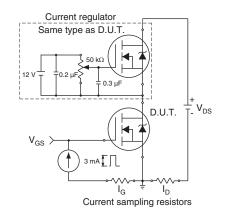


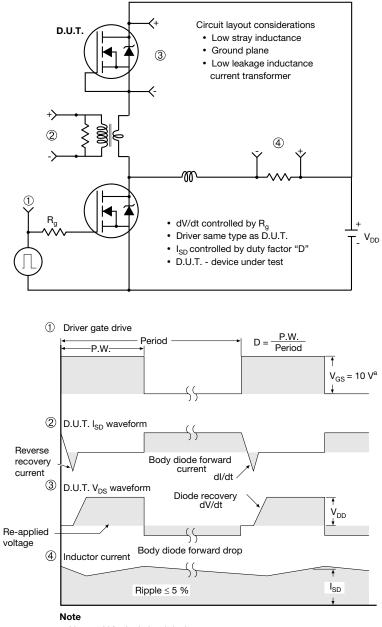
Fig. 13b - Gate Charge Test

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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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TO-247AC (High Voltage)

ECN: X13-0103-Rev. D, 01-Jul-13 DWG: 5971

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Contour of slot optional.

 Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.

4. Thermal pad contour optional with dimensions D1 and E1.

5. Lead finish uncontrolled in L1.

6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").

7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.

8. Xian and Mingxin actually photo.





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